onsemi

IGBT – **Power, Co-PAK** N-Channel, Field Stop VII (FS7), SCR, Power TO247-3L, 1200 V, 1.4 V, 100 A

FGY100T120RWD

Description

Using the novel field stop 7th generation IGBT technology and the Gen7 Diode in TO247 3–lead package, FGY100T120RWD offers the optimum performance with low conduction losses and good switching controllability for a high efficiency operation in various applications like motor control, UPS, data center and high–power switch.

Features

- Low Conduction Loss and Optimized Switching
- Maximum Junction Temperature $T_J = 175^{\circ}C$
- Positive Temperature Coefficient for Easy Parallel Operation
- High Current Capability
- 100% of the Parts are Dynamically Tested
- Short Circuit Rated
- RoHS Compliant

Applications

- Motor Control
- UPS
- General Application Requiring High Power Switch

MAXIMUM RATINGS (T_J = 25°C unless otherwise noted)

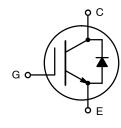
Parameter	Symbol	Value	Unit		
Collector to Emitter Voltage		V _{CES}	1200	V	
Gate to Emitter Voltage	V _{GES}	±20			
Transient Gate to Emitter		±30			
Collector Current	T _C = 25°C	Ι _C	200	Α	
	T _C = 100°C		100		
Power Dissipation	T _C = 25°C	PD	1495	W	
	$T_C = 100^{\circ}C$		747		
$\begin{array}{ll} \mbox{Pulsed Collector} & T_C = 25^\circ C, \\ \mbox{Current} & t_p = 10 \ \mu s \\ \mbox{(Note 1)} \end{array}$		I _{CM}	300	A	
Diode Forward	$T_{\rm C} = 25^{\circ}{\rm C}$	١ _F	200		
Current	$T_{\rm C} = 100^{\circ}{\rm C}$		100		
$ \begin{array}{llllllllllllllllllllllllllllllllllll$		I _{FM}	300		
Short Circuit Withstand Time $V_{GE} = 15 \text{ V}, V_{CC} = 600 \text{ V}, T_{C} = 150^{\circ}\text{C}$		T _{SC}	5	μs	
Operating Junction and Storage Temperature		T _J , T _{STG}	–55 to 175	°C	
Lead Temperature for Solo	ΤL	260			

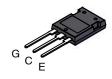
Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Repetitive rating: pulse width limited by max. Junction temperature.

BV _{CES}	V _{CE(SAT)}	Ι _C
1200 V	1.4 V	100 A

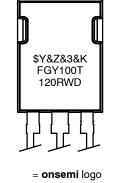
PIN CONNECTIONS





TO247-3LD CASE 340CD

MARKING DIAGRAM



= Assembly Plant Code

= 2-Digit Lot Traceability Code

FGY100T120RWD = Specific Device Code

\$Y

&Z

&З &К

ORDERING INFORMATION

Device	Package	Shipping
FGY100T120RWD	TO247–3LD (Pb–Free)	30 Units / Tube

^{= 3-}Digit Date Code

THERMAL CHARACTERISTICS

Parameter	Symbol	Max Value	Unit
Thermal Resistance, Junction to Case for IGBT	$R_{\theta JC}$	0.1	°C/W
Thermal Resistance, Junction to Case for Diode		0.19	
Thermal Resistance, Junction to Ambient	$R_{ hetaJA}$	40	

ELECTRICAL CHARACTERISTICS OF THE IGBT (T_J = $25^{\circ}C$ unless otherwise noted)

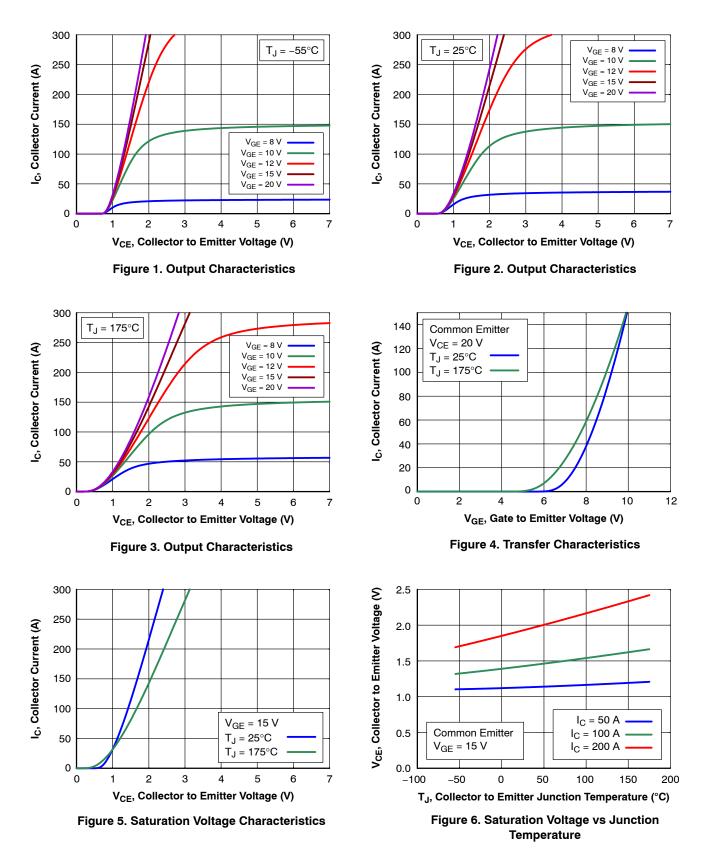
Voltage Constant of the second	Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit	
Voltage Image	OFF CHARACTERISTICS							
$ \begin{array}{ c c c c c c c c c c c c c c c c c c c$		BV _{CES}	V_{GE} = 0 V, I _C = 5 mA	1200	-	-	V	
$ \begin{array}{ c c c c c } Current & c c c c c c c c c c c c c c c c c c $		$\Delta BV_{CES} / \Delta T_J$	V_{GE} = 0 V, I _C = 5 mA	-	662	-	mV/°C	
		I _{CES}	V_{GE} = 0 V, V_{CE} = V_{CES}	-	-	40	μΑ	
	Gate to Emitter Leakage Current	I _{GES}	V_{GE} = 20 V, V_{CE} = 0 V	-	-	±400	nA	
$ \begin{array}{ c c c c c c c c c c c c c c c c c c c$	ON CHARACTERISTICS							
$ \begin{array}{ c c c c c } \hline V_{GE} = 15 V, I_{C} = 100 A, T_{J} = 175^{\circ}C & - & 1.66 & - \\ \hline V_{GE} = 15 V, I_{C} = 100 A, T_{J} = 175^{\circ}C & - & 1.66 & - \\ \hline DYNAMIC CHARACTERISTICS & & & & & & & & & & & & & & & & & & &$	Gate to Emitter Threshold Voltage	V _{GE(TH)}	$V_{GE} = V_{CE}$, $I_C = 100 \text{ mA}$	4.9	5.92	6.7	V	
$ \begin{array}{ c c c c c c c c c c c c c c c c c c c$		V _{CE(SAT)}	V_{GE} = 15 V, I _C = 100 A, T _J = 25°C	1.15	1.43	1.75	V	
$ \begin{array}{ c c c c c c c c c c c c c c c c c c c$	Voltage		V_{GE} = 15 V, I _C = 100 A, T _J = 175°C	-	1.66	-		
$ \begin{array}{ c c c c c } \hline \begin{tabular}{ c c c c c } \hline \begin{tabular}{ c c c c } \hline \begin{tabular}{ c c c c c c } \hline \begin{tabular}{ c c c c c c } \hline \begin{tabular}{ c c c c c c c } \hline \begin{tabular}{ c c c c c c c c c c c c c c c c c c c$	DYNAMIC CHARACTERISTICS							
$ \begin{array}{ c c c c c c } \hline Reverse Transfer Capacitance & C_{RES} & & & & & & & & & & & & & & & & & & &$	Input Capacitance	CIES	V_{CE} = 30 V, V_{GE} = 0 V, f = 1 MHz	-	12200	-	pF	
$ \begin{array}{ c c c c c } \hline Total Gate Charge & Q_G & Q_GE & Q_GE & Q_GE & Q_GE & Q_GE & & & & & & & & & & & & & & & & & & &$	Output Capacitance	C _{OES}		-	392	-		
Gate to Emitter Charge Q_{GE} $I_{C} = 100 \text{ A}$ $ 108$ $-$ Gate to Collector Charge Q_{GC} $ 108$ $ 101$ $-$ SWITCHING CHARACTERISTIC, INDUCTIVE LOAD Turn-On Delay Time $t_{d(on)}$ $V_{CE} = 600 \text{ V}, V_{GE} = 15 \text{ V}, \\ I_{C} = 50 \text{ A}, R_{G} = 4.7 \Omega, \\ T_{J} = 25^{\circ}C$ $ 74$ $ n$ Rise Time t_r $T_{J} = 25^{\circ}C$ $ 464$ $ n$ Turn-Off Switching Loss E_{on} $ 196$ $ n$ Turn-On Delay Time $t_{d(on)}$ $V_{CE} = 600 \text{ V}, V_{GE} = 15 \text{ V}, \\ I_{C} = 100 \text{ A}, R_{G} = 4.7 \Omega, \\ 4.54$ $ n$ Turn-On Switching Loss E_{ts} $ 3.43$ $ n$ Turn-On Delay Time $t_{d(on)}$ $V_{CE} = 600 \text{ V}, V_{GE} = 15 \text{ V}, \\ I_{J} = 25^{\circ}C$ $ 800$ $ n$ Turn-On Switching Loss E_{on} $ 100 \text{ A}, R_{G} = 4.7 \Omega, \\ I_{J} = 25^{\circ}C$ $ 800$ <td>Reverse Transfer Capacitance</td> <td>C_{RES}</td> <td></td> <td>-</td> <td>44.2</td> <td>-</td>	Reverse Transfer Capacitance	C _{RES}		-	44.2	-		
Gate to Emitter Charge Q_{GE} - 108 - Gate to Collector Charge Q_{GC} - 161 - SWITCHING CHARACTERISTIC, INDUCTIVE LOAD VCE = 600 V, VGE = 15 V, IC = 50 A, RG = 4.7 \Omega, TJ = 25°C - 74 - n Turn-On Delay Time $t_{d(off)}$ VCE = 50 A, RG = 4.7 \Omega, TJ = 25°C - 464 - n Fail Time tr - 464 - n Turn-Off Delay Time tr - 464 - n Fail Time tr - 453 - n Turn-On Switching Loss Eon - 453 - n Turn-On Delay Time td(off) VCE = 600 V, VGE = 15 V, IC = 100 A, RG = 4.7 \Omega, TJ = 25°C - 7.0 - Turn-On Delay Time td(off) VCE = 600 V, VGE = 15 V, IC = 100 A, RG = 4.7 \Omega, TJ = 25°C - 80 - n Turn-On Delay Time td(off) TJ = 25°C - 80 - 100 Turn-Off Delay Time td(off)	Total Gate Charge	Q _G		-	427	-	nC	
SWITCHING CHARACTERISTIC, INDUCTIVE LOAD VGE = 600 V, VGE = 15 V, IC = 50 A, RG = 4.7 \Omega, TJ = 25°C - 74 - n Turn-On Delay Time $t_{d(off)}$ $I_C = 50 A, R_G = 4.7 \Omega, TJ = 25°C$ - 464 - n Rise Time t_r $I_J = 25°C$ - 455 - n Turn-On Switching Loss E_{on} - 4.54 - n Turn-On Delay Time $t_{d(on)}$ VCE = 600 V, VGE = 15 V, IC = 100 A, RG = 4.7 \Omega, TO, TO, TO, TO, TO, TO, TO, TO, TO, TO	Gate to Emitter Charge	Q _{GE}	I _C = 100 A	-	108	-		
$ \begin{array}{ c c c c c c c c c c c c c c c c c c c$	Gate to Collector Charge	Q _{GC}		-	161	-		
Turn-Off Delay Time $t_{d(off)}$ $l_{C} = 50 \text{ A}, R_{G} = 4.7 \Omega, T_{J} = 25^{\circ}C$ $ 464$ $ n$ Rise Time t_{r} $T_{J} = 25^{\circ}C$ $ 464$ $ n$ Fall Time t_{f} $ 455$ $ n$ Turn-On Switching Loss E_{on} $ 3.43$ $ n$ Turn-On Switching Loss E_{off} $ 4.54$ $ n$ Turn-On Delay Time $t_{d(off)}$ $L_{C} = 600 \text{ V}, \text{ V}_{GE} = 15 \text{ V}, \\ L_{C} = 100 \text{ A}, R_{G} = 4.7 \Omega, \\ T_{J} = 25^{\circ}C$ $ 800$ $ n$ Turn-On Delay Time $t_{d(off)}$ $L_{C} = 100 \text{ A}, R_{G} = 4.7 \Omega, \\ T_{J} = 25^{\circ}C$ $ 800$ $ n$ Rise Time t_{r} $L_{C} = 100 \text{ A}, R_{G} = 4.7 \Omega, \\ T_{J} = 25^{\circ}C$ $ 855$ $ n$ Fall Time t_{r} $L_{C} = 100 \text{ A}, R_{G} = 4.7 \Omega, \\ T_{J} = 25^{\circ}C$ $ 855$ $ n$ Turn-On Switching Loss E_{off} $ -$	SWITCHING CHARACTERISTIC, II	NDUCTIVE LOAD)					
$\begin{array}{ c c c c c c c c c c c c c c c c c c c$	Turn-On Delay Time	t _{d(on)}	$V_{CE} = 600 \text{ V}, V_{GE} = 15 \text{ V},$	-	74	-	ns	
Fall Time t_f $ 196$ $-$ Turn-On Switching Loss E_{on} $ 3.43$ $ -$ Turn-Off Switching Loss E_{off} $ 4.54$ $ -$ Total Switching Loss E_{ts} $ -$ Turn-On Delay Time $t_{d(on)}$ $t_{C} = 600 V, V_{GE} = 15 V, t_{C} = 100 A, R_G = 4.7 \Omega, T_{J} = 25^{\circ}C$ $ -$ <td>Turn-Off Delay Time</td> <td>t_{d(off)}</td> <td rowspan="2"></td> <td>-</td> <td>464</td> <td>-</td> <td>ns</td>	Turn-Off Delay Time	t _{d(off)}		-	464	-	ns	
$ \begin{array}{ c c c c c c c c c c c c c c c c c c c$	Rise Time	t _r		-	45	-	ns	
$ \begin{array}{ c c c c c c c c } \hline Turn-Off Switching Loss & E_{off} & & & & & & & & & & & & & & & & & & $	Fall Time	t _f		-	196	-		
$ \begin{array}{c c c c c c c c c c c c c c c c c c c $	Turn-On Switching Loss	E _{on}		-	3.43	-	mJ	
$ \begin{array}{c c c c c c c c c c c c c c c c c c c $	Turn-Off Switching Loss	E _{off}		-	4.54	-		
$ \begin{array}{c c c c c c c c c c c c c c c c c c c $	Total Switching Loss	E _{ts}		-	7.97	-		
$\begin{array}{c c c c c c c c c c c c c c c c c c c $	Turn-On Delay Time	t _{d(on)}	I _C = 100 A, R _G = 4.7 Ω,	-	80	-	ns	
Rise Time tr - 85 - n Fall Time tf - 180 - n Turn-On Switching Loss Eon - 8.13 - m Turn-Off Switching Loss Eoff - 7.05 - m	Turn-Off Delay Time	t _{d(off)}		-	364	-	ns	
Turn-On Switching Loss Eon - 8.13 - m Turn-Off Switching Loss Eoff - 7.05 - -	Rise Time	t _r		-	85	-	ns	
Turn-Off Switching Loss E _{off} - 7.05 -	Fall Time	t _f		_	180	-		
	Turn-On Switching Loss	E _{on}		-	8.13	-	mJ	
Total Switching Loss E _{ts} – 15.18 –	Turn-Off Switching Loss	E _{off}		-	7.05	-		
	Total Switching Loss	E _{ts}		-	15.18	-		

ELECTRICAL CHARACTERISTICS OF THE IGBT (T_J = 25°C unless otherwise noted) (continued)

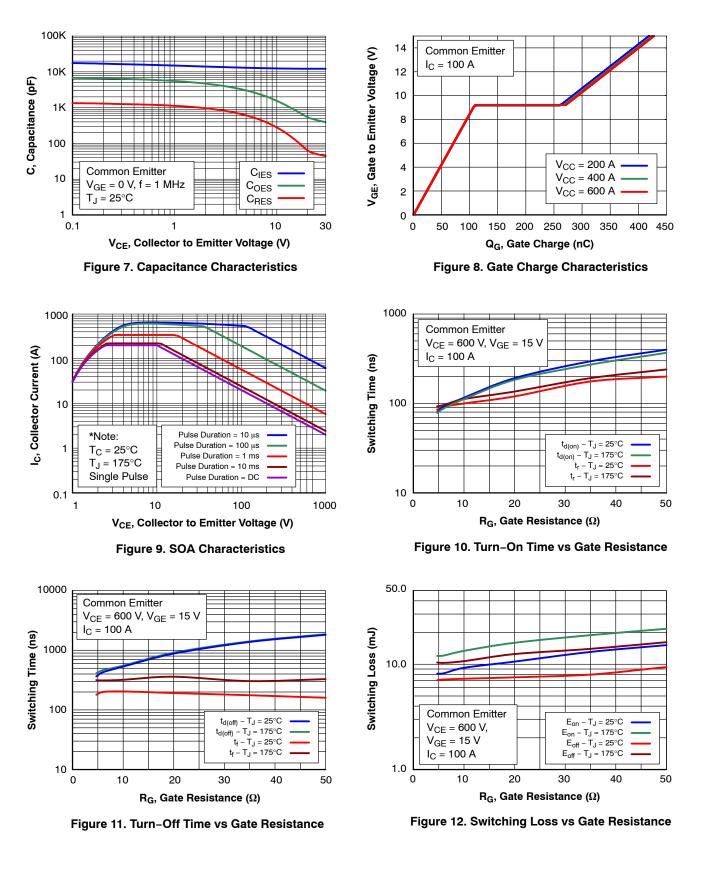
Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit
SWITCHING CHARACTERISTIC, II	NDUCTIVE LOA	\D				
Turn-On Delay Time	t _{d(on)}	$V_{CE} = 600 \text{ V}, V_{GE} = 15 \text{ V},$	-	70	-	ns
Turn-Off Delay Time	t _{d(off)}	I _C = 50 A, R _G = 4.7 Ω, T _J = 175°C	-	536	-	ns
Rise Time	t _r		-	50	-	ns
Fall Time	t _f		-	348	-	
Turn-On Switching Loss	E _{on}		-	5.58	-	mJ
Turn-Off Switching Loss	E _{off}		-	6.83	-	
Total Switching Loss	E _{ts}		-	12.41	-	
Turn-On Delay Time	t _{d(on)}	$V_{CE} = 600 \text{ V}, V_{GE} = 15 \text{ V},$	-	78	-	ns
Turn-Off Delay Time	t _{d(off)}	− I _C = 100 A, R _G = 4.7 Ω, T _J = 175°C	-	412	-	ns
Rise Time	t _r		-	93	-	ns
Fall Time	t _f		-	316	-	
Turn-On Switching Loss	E _{on}		-	12.00	-	mJ
Turn-Off Switching Loss	E _{off}		-	10.30	-	-
Total Switching Loss	E _{ts}		-	22.30	-	
DIODE CHARACTERISTIC						
Diode Forward Voltage	V _F	I _F = 100 A, T _J = 25°C	1.46	1.80	2.08	V
		I _F = 100 A, T _J = 175°C	-	1.90	-	
DIODE SWITCHING CHARACTER	STIC, INDUCTI	VE LOAD				
Reverse Recovery Time	t _{rr}	$V_{\rm R} = 600 \text{ V}, I_{\rm F} = 50 \text{ A},$	-	256	-	ns
Reverse Recovery Charge	Q _{rr}	dl _F /dt = 500 A/μs, T _J = 25°C	-	3140	-	nC
Reverse Recovery Energy	E _{rec}		-	1	-	mJ
Peak Reverse Recovery Current	I _{RRM}		-	24.5	-	А
Reverse Recovery Time	t _{rr}	$V_{\rm R} = 600 \text{ V}, I_{\rm F} = 100 \text{ A},$	-	347	-	ns
Reverse Recovery Charge	Q _{rr}	dI _F /dt = 500 A/µs, T _J = 25°C	-	4408	-	nC
Reverse Recovery Energy	E _{rec}		-	2	-	mJ
Peak Reverse Recovery Current	I _{RRM}		-	25.8	-	А
Reverse Recovery Time	t _{rr}	$V_{R} = 600 V, I_{F} = 50 A,$ dI _F /dt = 500 A/µs, T _J = 175°C	-	424	-	ns
Reverse Recovery Charge	Q _{rr}		-	8610	-	nC
Reverse Recovery Energy	E _{rec}		-	4	-	mJ
Peak Reverse Recovery Current	I _{RRM}		-	40.8	-	А
Reverse Recovery Time	t _{rr}	$V_{\rm R} = 600 \text{ V}, I_{\rm F} = 100 \text{ A},$	-	572	-	ns
Reverse Recovery Charge	Q _{rr}	dI _F /dt = 500 A/µs, T _J = 175°C	-	12476	-	nC
Reverse Recovery Energy	E _{rec}		-	5	-	mJ
Peak Reverse Recovery Current	I _{RRM}	1	-	43.6	-	А

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS (CONTINUED)



TYPICAL CHARACTERISTICS (CONTINUED)

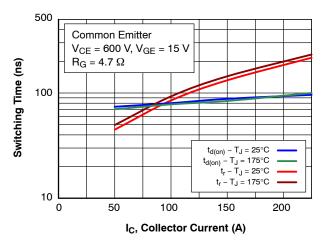


Figure 13. Turn-On Time vs Collector Current

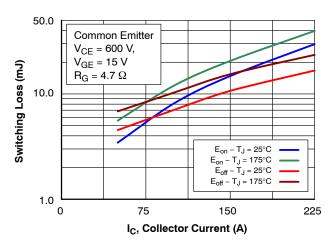


Figure 15. Switching Loss vs Collector Current

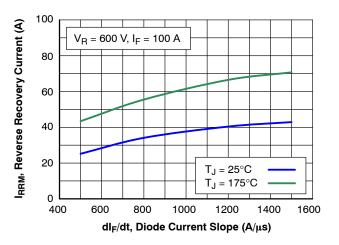


Figure 17. Diode Reverse Recovery Current

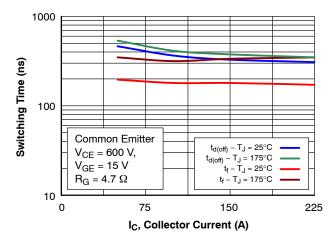


Figure 14. Turn-Off Time vs Collector Current

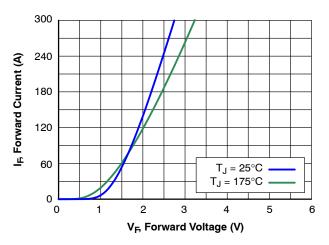


Figure 16. Diode Forward Characteristics

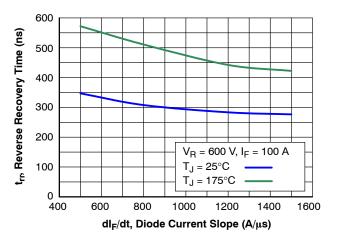
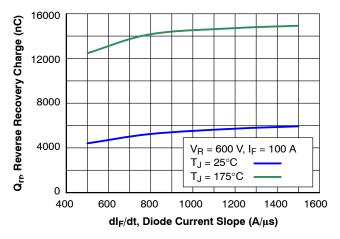
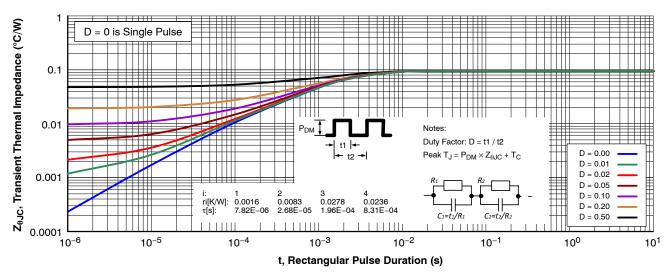


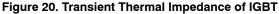
Figure 18. Diode Reverse Recovery Time

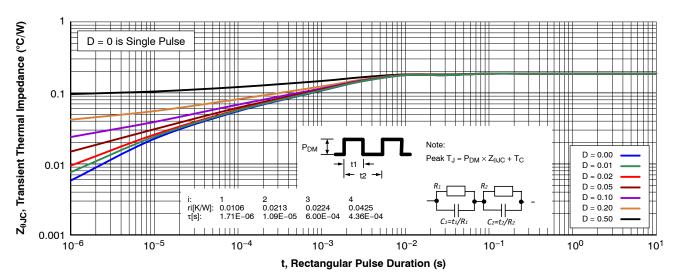
TYPICAL CHARACTERISTICS (CONTINUED)





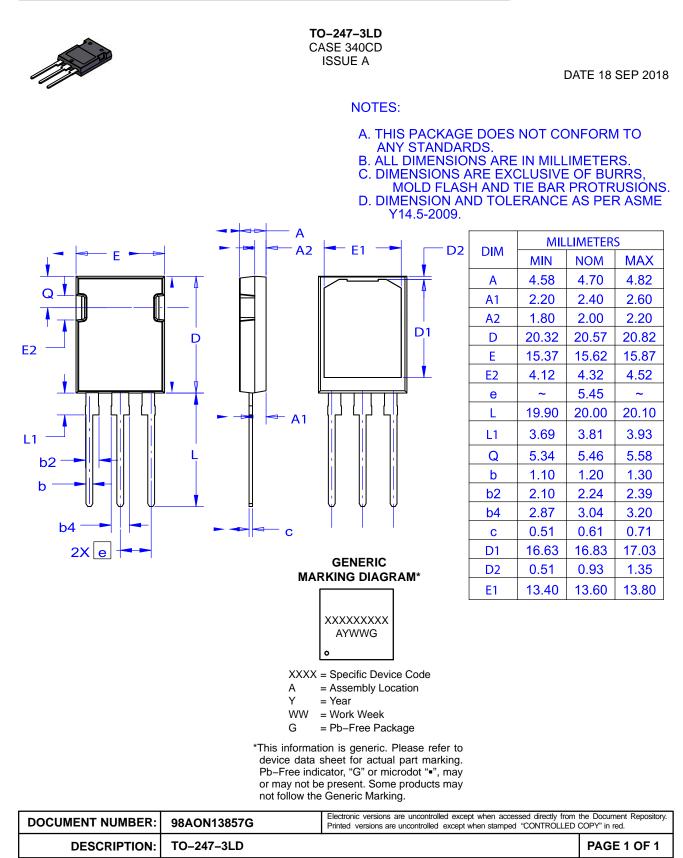












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